

L Number	Hits	Search Text	DB	Time stamp
4	2	("6284309").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 16:01
-	4	(roughen\$3 same copper) same (tetrazole same benzotriazole)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/10 21:33
-	44184	copper same (etch\$3 or roughen\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:08
-	42	(copper same (etch\$3 or roughen\$3)) same (post near clean\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:12
-	11	((copper same (etch\$3 or roughen\$3)) same (post near clean\$3)) and (aluminate or silane)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:12
-	10	((copper same (etch\$3 or roughen\$3)) same (post near clean\$3)) and (aluminate or silane)) and @pd<20000107	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:18
-	0	((copper same (etch\$3 or roughen\$3)) same (post near clean\$3)) and (aluminate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:12
-	157	(copper same (etch\$3 or roughen\$3)) and (post near clean\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:13
-	167	(copper same (etch\$3 or roughen\$3)) and (post near (clean\$3 or dipp\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:14
-	0	(copper same (etch\$3 or roughen\$3)) and ((post near (clean\$3 or dipp\$3)) same aluminate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:14
-	2	((copper same (etch\$3 or roughen\$3)) and (post near (clean\$3 or dipp\$3))) and aluminate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:17
-	1102	aluminate same zirconate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:29
-	1	((aluminate same zirconate) same (copper near polsih\$3 or roughen\$3 or etch\$3)) and @pd<20000107	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:33

-	6	(aluminate same zirconate) same (copper near polsih\$3 or roughen\$3 or etch\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:30
-	364	(aluminate same zirconate) and (copper near polsih\$3 or roughen\$3 or etch\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:32
-	3	((aluminate same zirconate) and (copper near polsih\$3 or roughen\$3 or etch\$3)) and ((post near clean\$3) or (post near dipp\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:31
-	2	((aluminate same zirconate) and (copper near polsih\$3 or roughen\$3 or etch\$3)) and 252/79.1.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:32
-	64	((aluminate same zirconate) and (copper near polsih\$3 or roughen\$3 or etch\$3)) and @pd<20000107	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 16:01